

DISPLAY Elektronik GmbH

DATA SHEET

TFT MODULE

**DEM 800480Q4 VMX-PW-N
(C1-TOUCH)**

Product specification

Version:1

15.03.2022

GENERAL SPECIFICATION

MODULE NO. :

DEM 800480Q4 VMX-PW-N
(C1-TOUCH)

CUSTOMER

VERSION NO.	CHANGE DESCRIPTION	DATE
0	Original version	24.03.2022
1	Add the touch panel drawing	15.03.2022

PREPARED BY: YK

DATE: 15.03.2022

APPROVEDBY: WH

DATE: 15.03.2022

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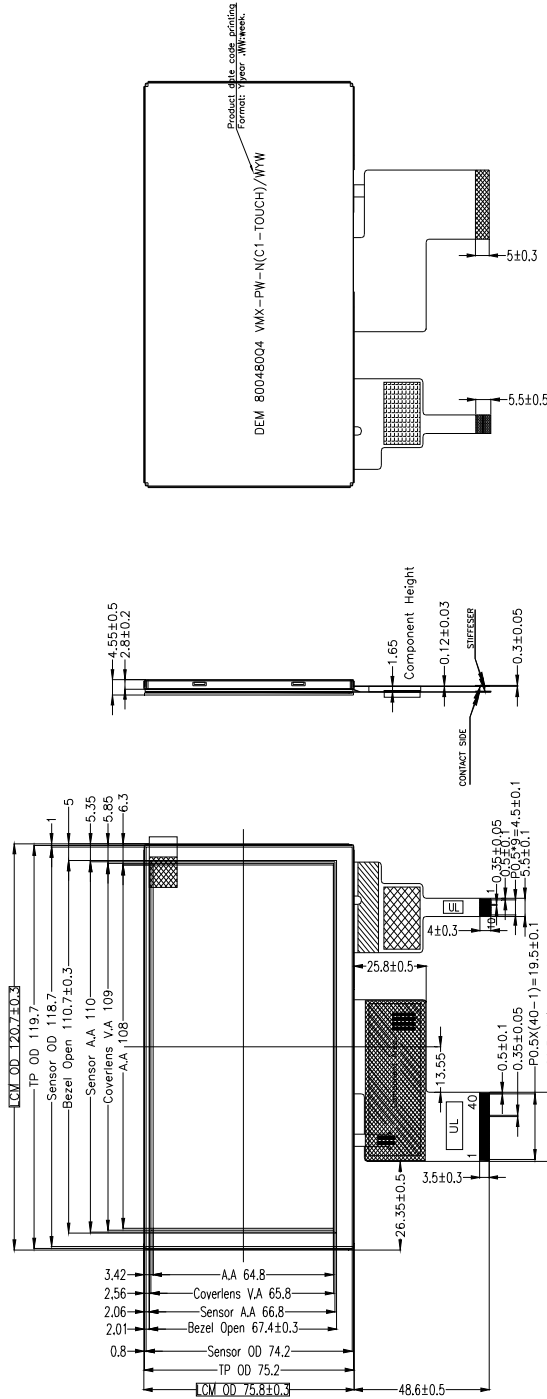
1. GENERAL SPECIFICATIONS

ITEM	STANDARD VALUE	UNIT
LCD SIZE	5.0' TFT	inth
LCD TYPE	TFT/IPS/NORMALLY BLACK/TRANSMISSIVE	
MODULE SIZE	120.70 x 75.80 x 4.55	mm
ACTIVE AREA	108.00 x 64.80	mm
PIXEL PITCH (W*H)	0.135 x 0.135	
NUMBER OF PIXELS	800 x 480	
DIVER IC	ST7262	
INTERFACE TYPE	RGB	
RECOMMEND VIEWING DIRECTION	ALL	o'clock
GRAY SCALE INVERSION DIRECTION	-	o'clock
COLORS	16.7 MILLION	
BACKLIGHT TYPE	20-DIES WHITE LED	
TOUCH PANEL TYPE	CTP	

Touch Panel Features:

ITEM	CONTENS
Type	Capacitive Multi-touch
Module size	119.70 (L)mm x 75.20 (W)mm x 1.75 (T) mm
View area	109.00(W)mm x 65.80(H)mm
Interface	I2C
Operation Voltage	2.8V~3.3V
ITO Glass thickness	0.7mm
Operation humidity	20~90%RH
Storage humidity	20~90%RH
Driver IC	FT5426-003
Resolution	800x480
Input force	□10g
Input method	Finger or exclusive pen
Transparency	80%
Surface hardness	>6H
Hitting life	>35,000,000 times
Insulation	20M ohm or over(Dc 25V)
ESD(Human body model)	±2000 V

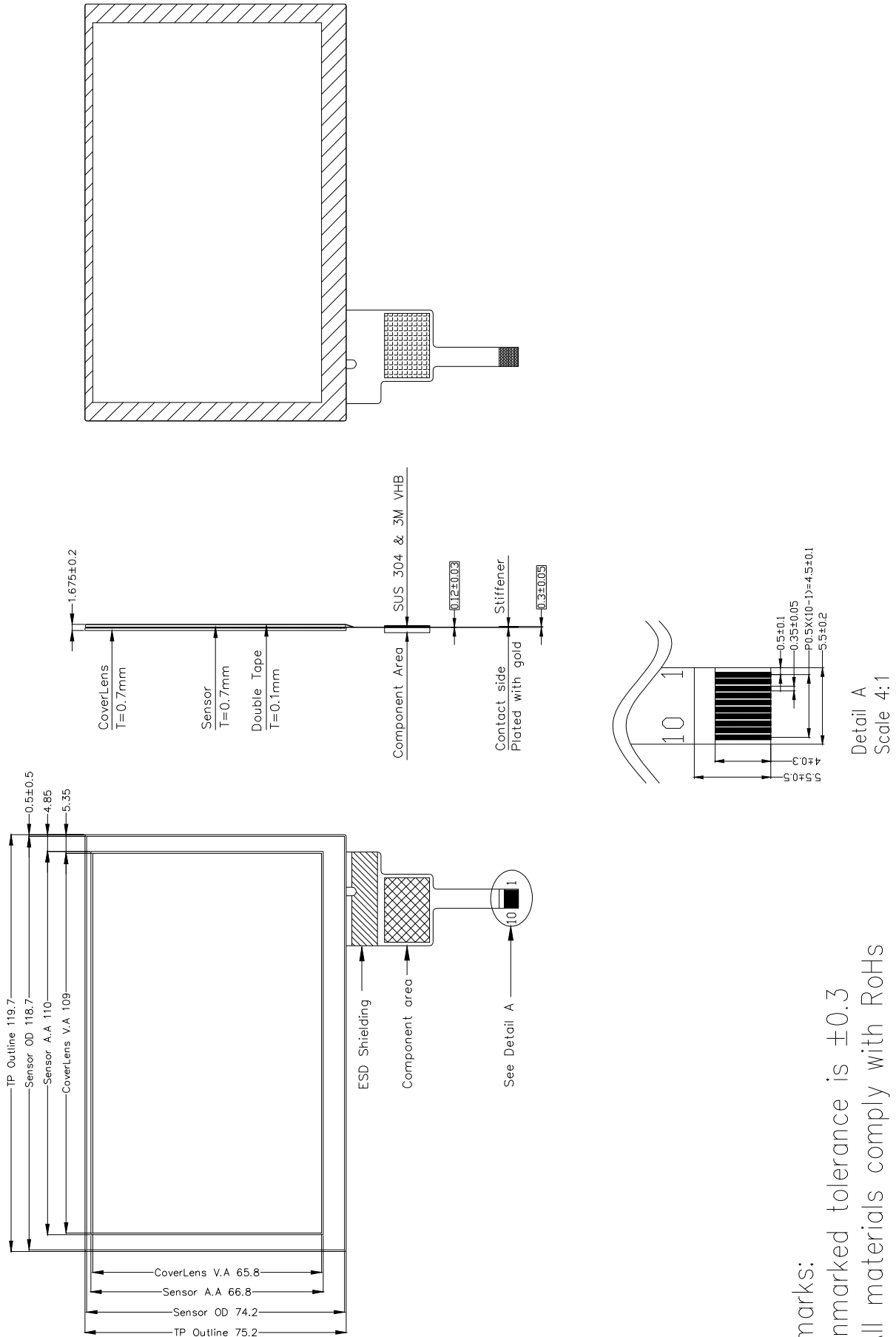
2. EXTERNAL DIMENSIONS



LED CIRCUIT DIAGRAM: 5*4 Dice
 80mA @ 16V
 Brightness 800cd/m² (Min)

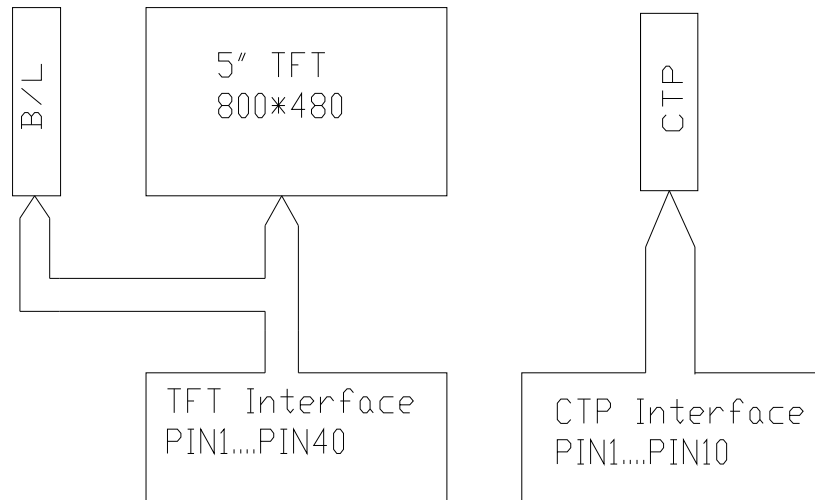
- Remark:
1. Unmarked tolerance is ±0.3
 2. All materials comply with RoHS
 3. [] ...:critical dimension.
 4. LED Lifetime: 50000h.
 5. Operating Temperature: -30~+85°C

TOUCH PANEL DRAWING:



- Remarks:
- 1.Unmarked tolerance is ±0.3
 - 2.All materials comply with RoHs
 - 3.FPC加上UL标识.

3. BLOCK DIAGRAM



4. PIN ASSIGNMENT

PIN NO.	SYMBOL	DESCRIPTION
1	VLED-	Cathode of LED back light
2	VLED+	Anode of LED back light
3	GND	Power ground
4	VDD	Power voltage
5	R0	Red data
6	R1	Red data
7	R2	Red data
8	R3	Red data
9	R4	Red data
10	R5	Red data
11	R6	Red data
12	R7	Red data
13	G0	Green data
14	G1	Green data
15	G2	Green data
16	G3	Green data
17	G4	Green data
18	G5	Green data
19	G6	Green data
20	G7	Green data
21	B0	Blue data
22	B1	Blue data
23	B2	Blue data
24	B3	Blue data
25	B4	Blue data
26	B5	Blue data
27	B6	Blue data
28	B7	Blue data
29	GND	Power ground
30	CLK	Sample clock
31	DISP	Display on/off
32	NC/HS	No connection
33	NC/VS	No connection

34	DE	Data input enable
35	NC	No connection
36	GND	Power ground
37	NC	No connection
38	NC	No connection
39	NC	No connection
40	NC	No connection

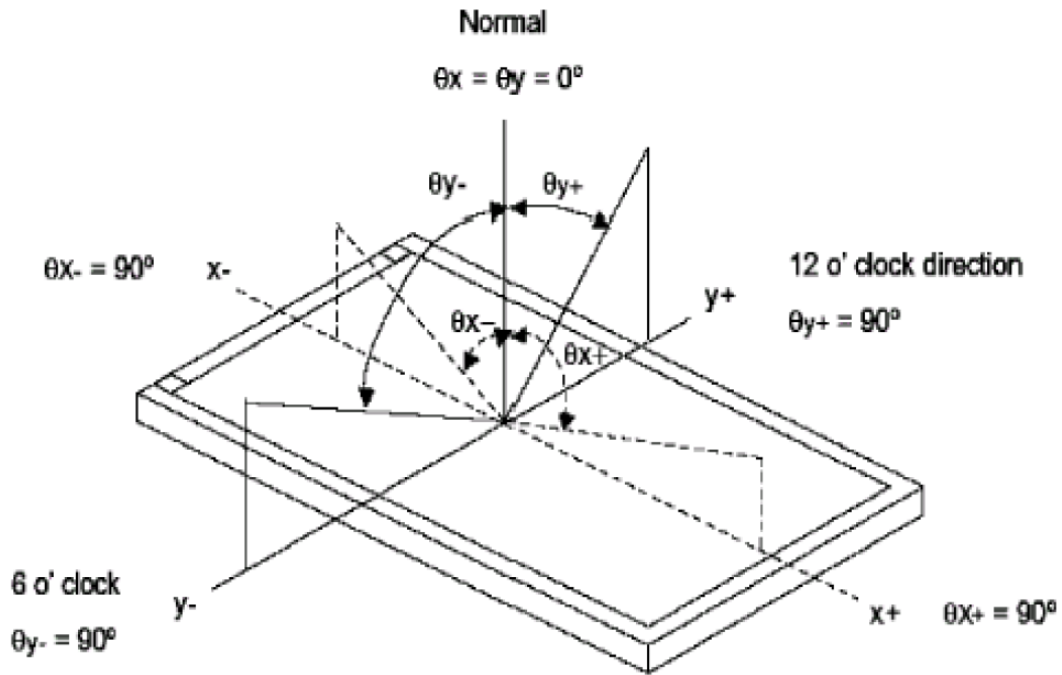
TOUCH PANEL

PIN NO.	SYMBOL	DESCRIPTION
1	VSS	Negative supply
2	VDDT	Positive power supply
3	SCL	I2C Serial clock input/output
4	NC	No connection
5	SDA	I2C Serial data input/output
6	NC	No connection
7	/RST	Global reset input, low active
8	NC	No connection
9	/INT	External Interrupt
10	VSS	Negative supply

5. OPTICAL CHARACTERISTICS

ITEM	SYMBOL	CONDITIONS	SPECIFICATIONS			UNIT	NOTE
			MIN	TYP.	MAX		
Luminance	L		-	800	-	Cd/m ²	
Contrast Ratio	CR	$\theta = 0^\circ$	800	1000			
Response Time	Ton+ Toff	25°C		30	40	ms	
CIE COLOUR COORDINATE	RED	XR	VIEWING NORMAL ANGLE		0.629		
		YR			0.326		
	GREEN	XG			0.337		
		YG			0.546		
	BLUE	XB			0.136		
		YB			0.143		
	WHITE	XW			0.320		
		YW			0.345		
VIEWING ANGLE	Hor.	θ_{x+}	CR \geq 10	70	80	Degree	
		θ_{x-}		70	80		
	Ver.	θ_{y+}		70	80		
		θ_{y-}		70	80		

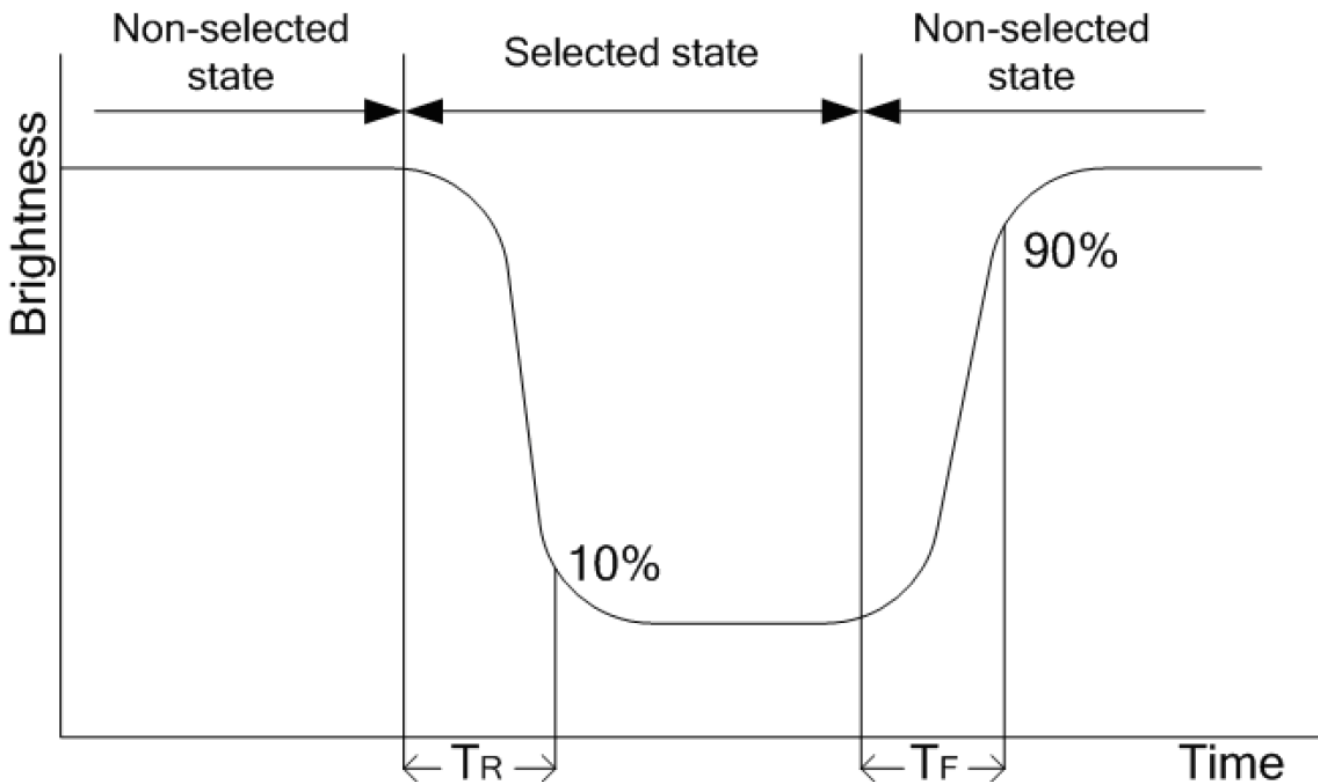
Note 1 : Definition of Viewing Angle θ_x and θ_y :



Note 2: Definition of contrast ratio CR:

$$CR = \frac{\text{Brightness of non-selected dots (white)}}{\text{Brightness of selected dots (black)}}$$

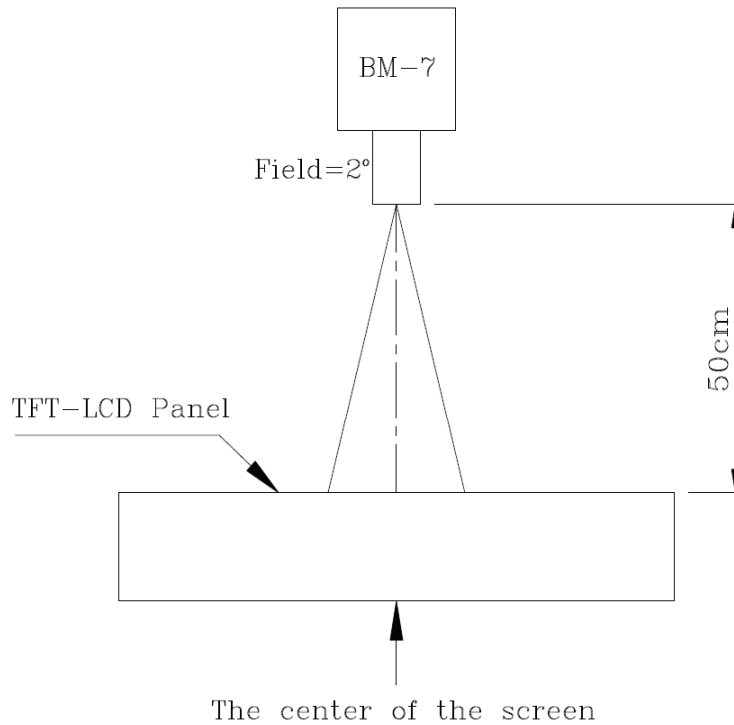
Note 3: Definition of response time (T_R , T_F)



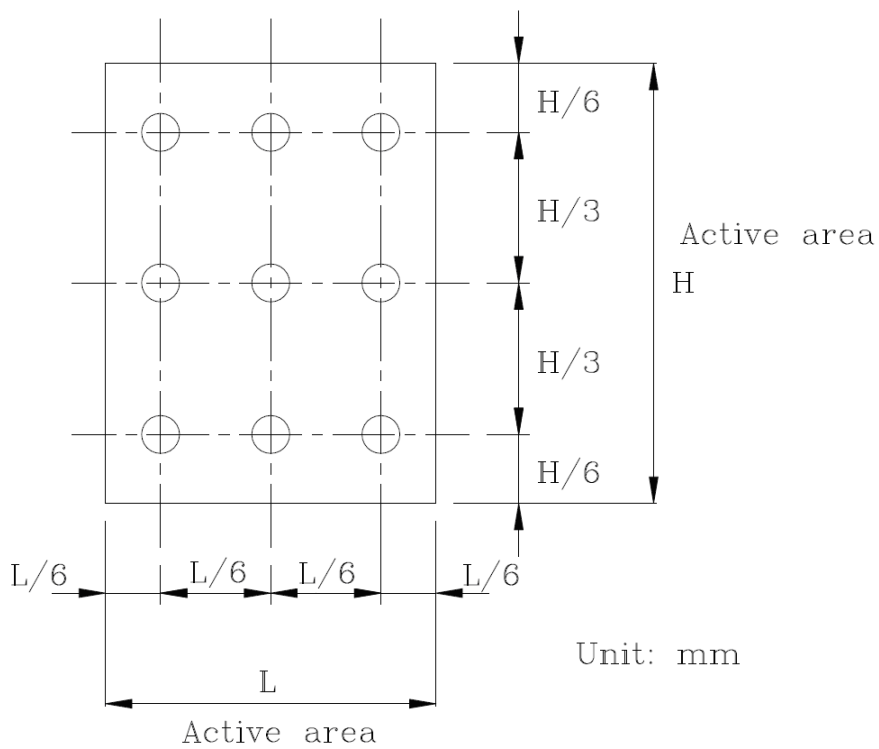
Note 4: Definition of Luminance

①The Brightness Test Equipment Setup

Field=2° (As measuring “black” image, field=2° is the best testing condition)



②The Brightness Test Point Setup



6. ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	MIN	MAX	UNIT
Power Supply Voltage	VDD	-0.3	4	V
Operating Temperature	Top	-30	+85	°C
Storage Temperature	Tst	-30	+85	°C

7. ELECTRICAL CHARACTERISTICS**7.1 ELECTRICAL CHARACTERISTICS**

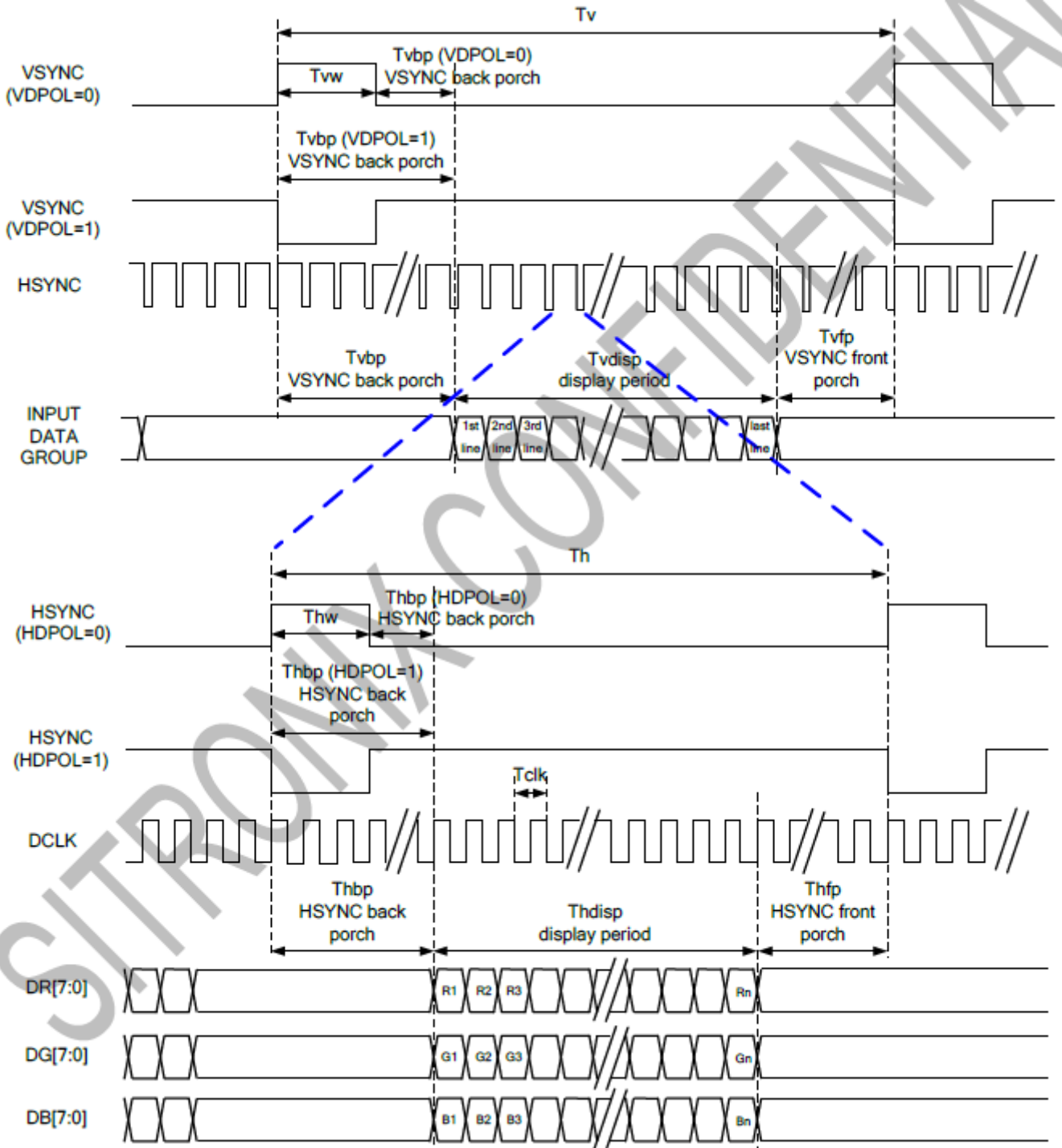
ITEM	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage for Analog	VDD	3.1	3.3	3.5	V
Current for Driver(Black)	IDD		110	170	mA
Input Voltage	Vil	GND	-	0.3VDD	V
	Vih	0.7VDD	-	VDD	V

7.2 BLACKLIGHT DRIVING CONDITIONS

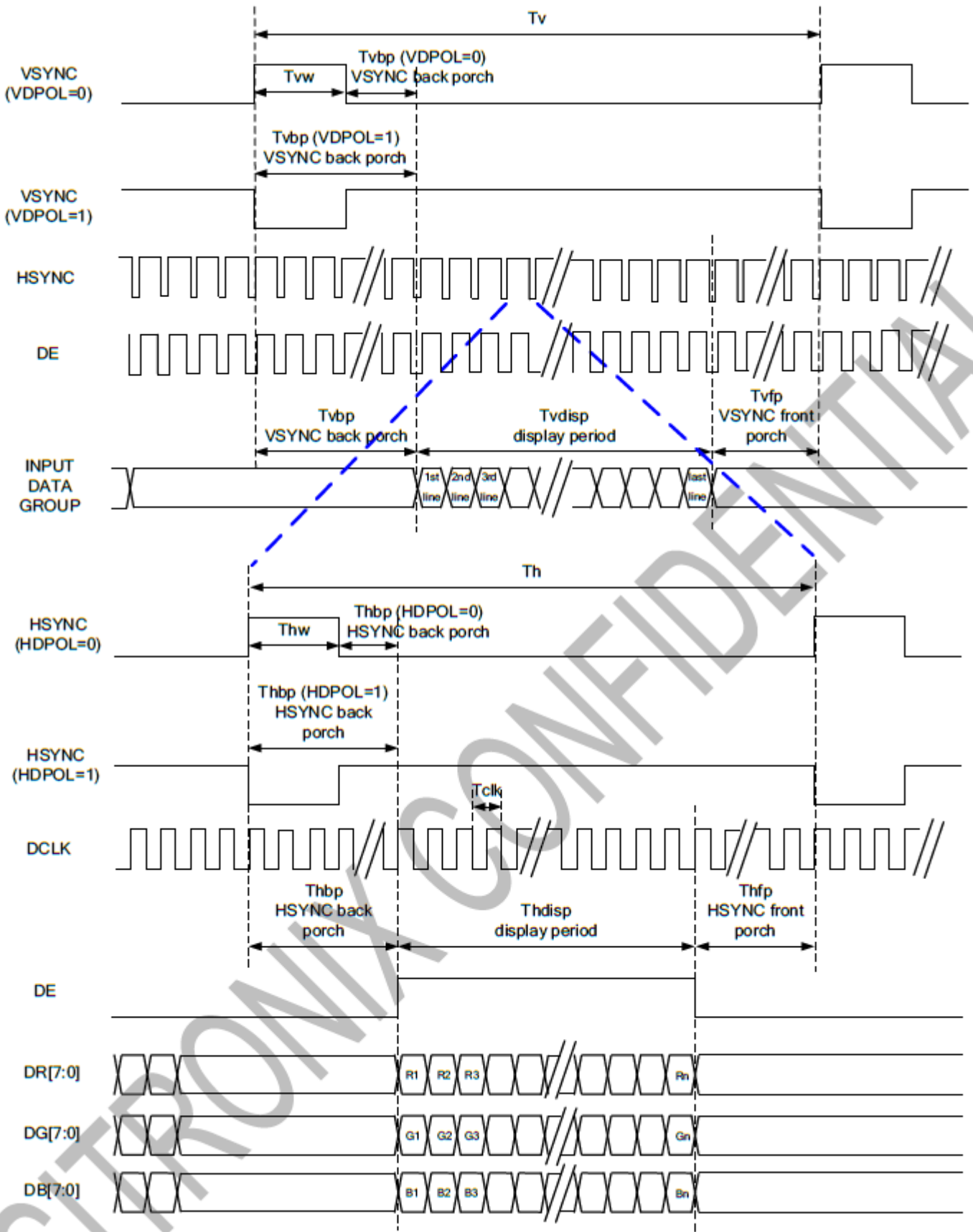
ITEM	SYMBOL	MIN	TYP.	MAX	UNIT
Voltage for LED Backlight	VL	18	16	20	V
Current for LED Backlight	IL		80		mA
LED Lifetime			50000		Hr

7.3 TIMING CHARACTERISTICS

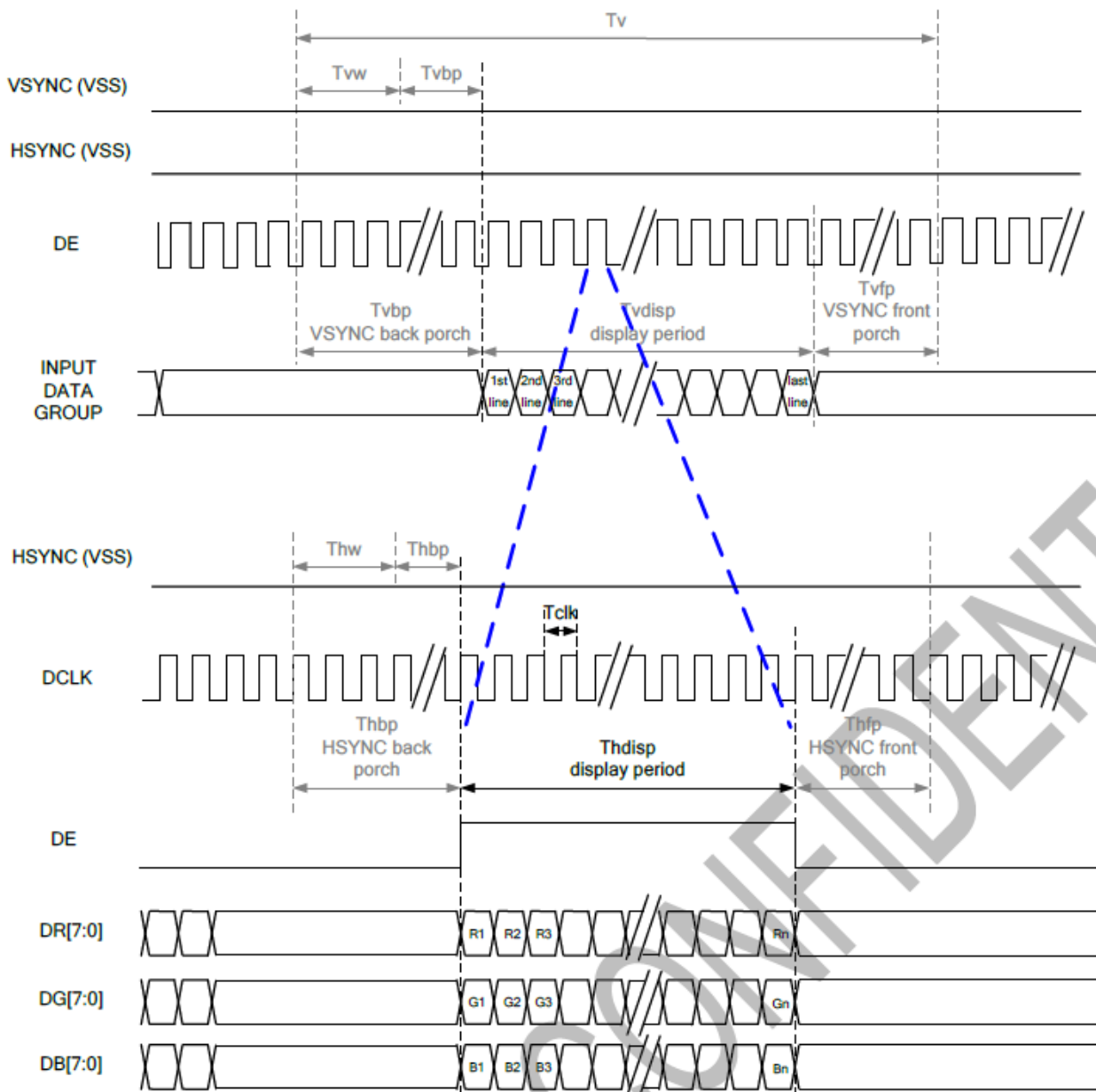
7.3.1 SYNC MODE



7.3.2 SYNC DE MODE



7.3.3 DE MODE



7.3.4 PARALLEL 24-BIT RGB INPUT TIMING TABLE

Parallel 24-bit RGB Input Timing (PVDD=PVDD1=VDD=VDDI= 3.3V, AGND= 0V, TA=25°C)

Parallel 24-bit RGB Interface Timing Table							
Item	Symbol	Min.	Typ.	Max.	Unit	Remark	
DCLK Frequency	Fclk	23	25	27	MHz		
HSYNC	Period Time	Th	808	816	896	DCLK	
	Display Period	Thdisp	800			DCLK	
	Back Porch	Thbp	4	8	48	DCLK	
	Front Porch	Thfp	4	8	48	DCLK	
	Pulse Width	Thw	2	4	8	DCLK	
VSYNC	Period Time	Tv	488	496	504	HSYNC	
	Display Period	Tvdisp	480			HSYNC	
	Back Porch	Tvbp	4	8	12	HSYNC	
	Front Porch	Tvfp	4	8	12	HSYNC	
	Pulse Width	Tvw	2	4	8	HSYNC	

8. RELIABILITY TEST

NO.	TEST ITEM	CONDITIONS	
1	HIGH TEMPERATURE STORAGE	TA=85°C	240H
2	LOW TEMPERATURE STORAGE	TA=-30°C	240H
3	HIGH TEMPERATURE OPERATION	TA=85°C	240H
4	LOW TEMPERATURE OPERATION	TA=-30°C	240H
5	HIGH TEMPERATURE AND HIGH HUMIDITY OPERATION	+60°C, 90%RH	240H

9. LCD MODULES HANDLING PRECAUTIONS

- n** The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- n** If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance come into contact with your skin or clothes promptly wash it off using soap and water.
- n** Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- n** The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarize carefully.
- n** To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Be sure to ground the body when handling the LCD module.
 - Tools required for assembly, such as soldering irons, must be properly grounded.
 - To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- n** Storage precautions
When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below 0°C).
Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

10. OTHERS

- n** Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- n** If the LCD modules have been operating for a long time showing the same display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.
- n** To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules:
 - Exposed area of the printed circuit board
 - Terminal electrode sections.